



ENVIRONMENTAL AND PACKAGE TESTING DATA FOR SC-75A

Stress	Sample Size	Device Hr./Cyc	Condition	Total Fails	Fail Percentage
HAST	610	610,000	130°C, 85%RH	0	0.00
Pressure Pot	1,610	152,260	121°, 15 PSIG	0	0.00
Solder DUNK	335	1,245	260°C, 10SEC	0	0.00
Solderability	195	1,485	883 M2003	0	0.00
Temp Cycle	1,610	570,000	-65°C-150°C	0	0.00